



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

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Pb-free
HEAT

STANLEY

AA□ 101 Series

Alpha-Numeric Display/Case Size 22.8 x 33.0 mm

Features

Case Size	22.8 x 33 mm (W x H)
Product features	<ul style="list-style-type: none">Each color has anode common.A black case is available.Lead-free soldering compatibleRoHS compliant
Peak wavelength	Orange : 605nm Red : 660nm
Number of Digit	1 Digit
Segment Shape	Arrow Feather Type
Character Height	25.4 mm
Die materials	Orange : GaAsP Red : GaAlAs
Soldering methods	TTW (Through The Wave) soldering and manual soldering
ESD	More than 2kV(HBM)
Packing	Tray

Recommended Applications

Amusement Equipment, Electric Household Appliances, Other General Applications

Emitted Color

Part No.	Material	Emitted Color	Chip/Segment
Anode Common Case Color Black			
AAA101-B	GaAsP	Orange	1
			2
AAR101-B	GaAIAs	Red	1
			2
AAR101-C	GaAIAs	Red	1
			2

Absolute Maximum Ratings

(Ta=25°C)

Item	Symbol	Absolute Maximum Ratings				Unit
		Orange		Red		
		Chip/Segment				
		1	2	1	2	
Power Dissipation	Pd	60	120	50	100	mW/seg
Forward Current	I _F	25		25		mA/seg
Pulse Forward Current * 1	I _{FRM}	100		100		mA/seg
Derating (Ta=25°C or higher)	ΔI _F	0.33		0.33		mA/°C
	ΔI _{FRM}	1.65		1.65		mA/°C
Reverse Voltage	V _R	4	8	4	8	V
Operating Temperature	T _{opr}	-20 ~ +85		-20 ~ +85		°C
Storage Temperature	T _{stg}	-20 ~ +100		-20 ~ +100		°C

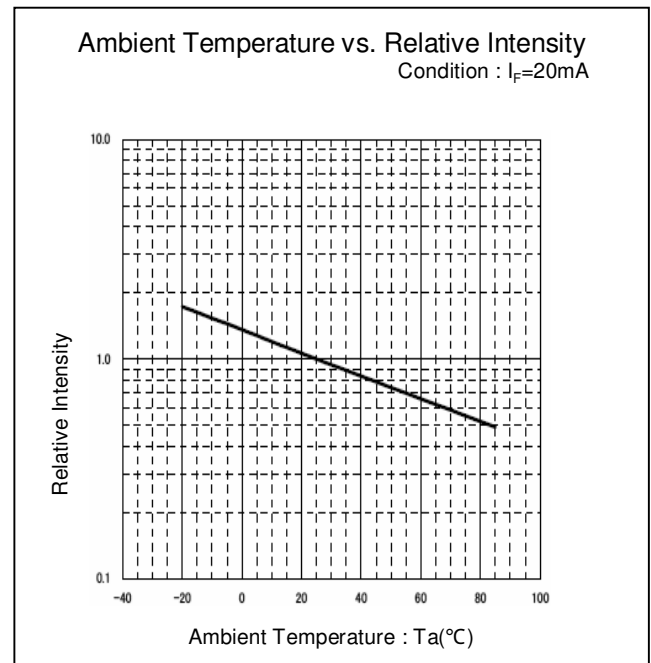
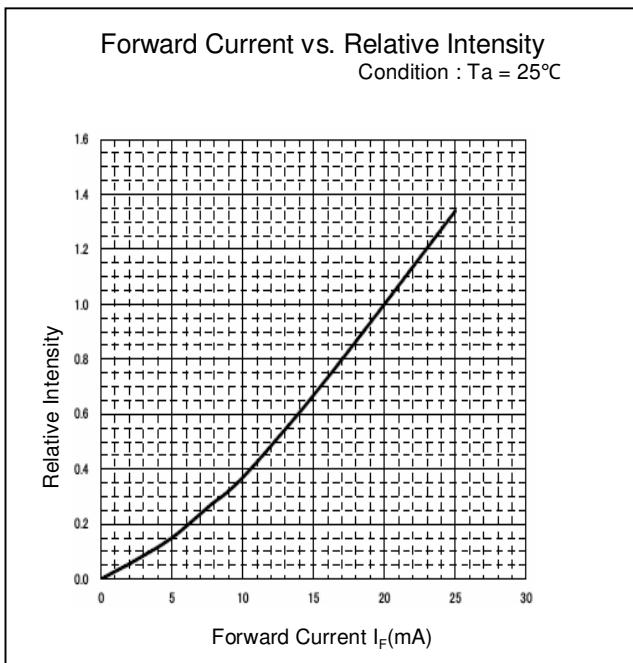
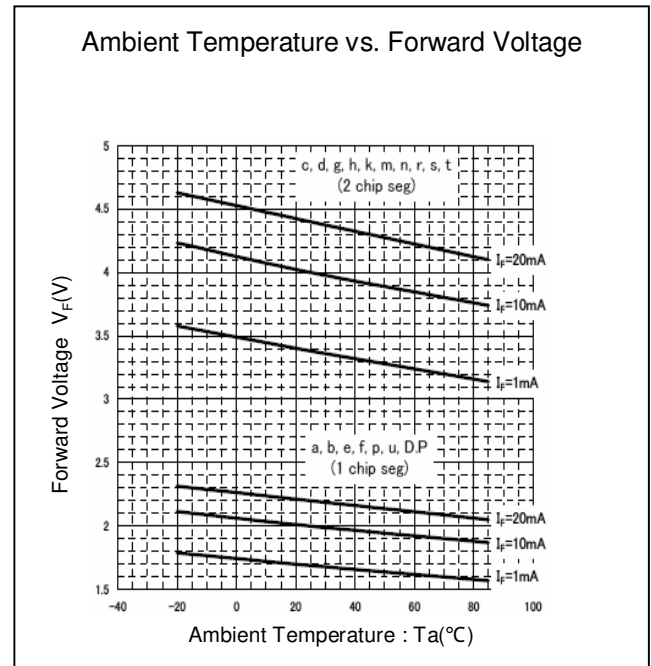
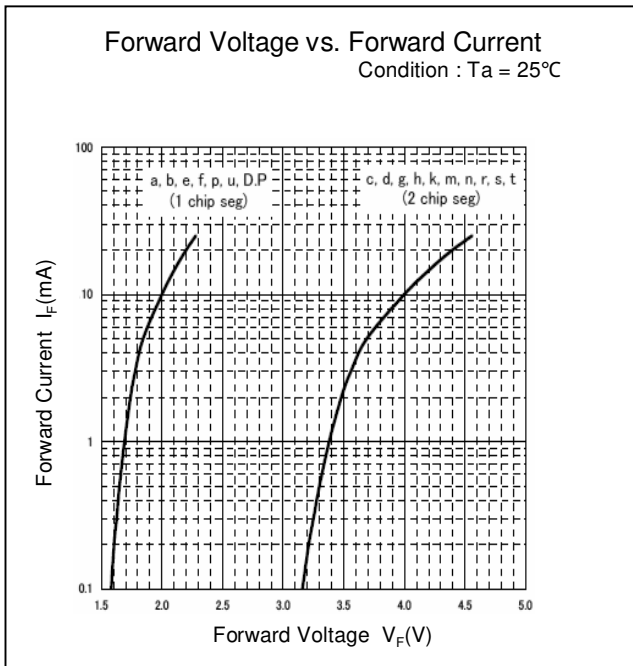
 * 1 I_{FRM} Measurement condition : Duty 1/5, f = 1kHz

Electro-Optical Characteristics

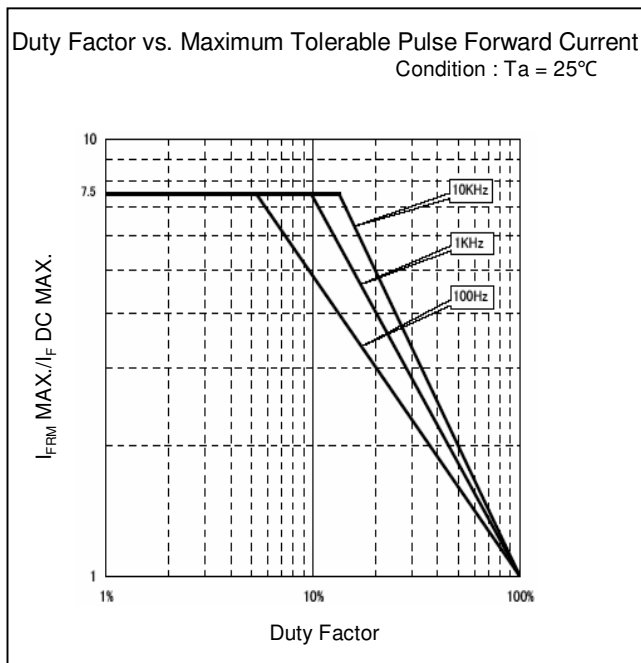
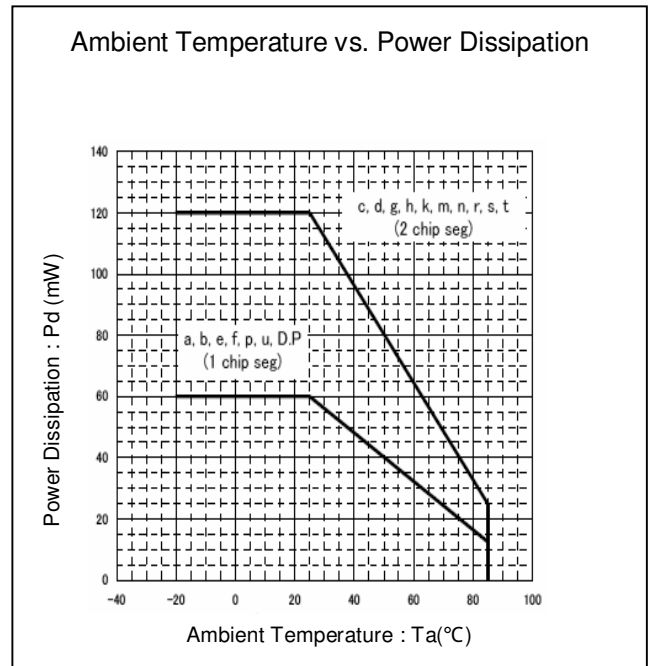
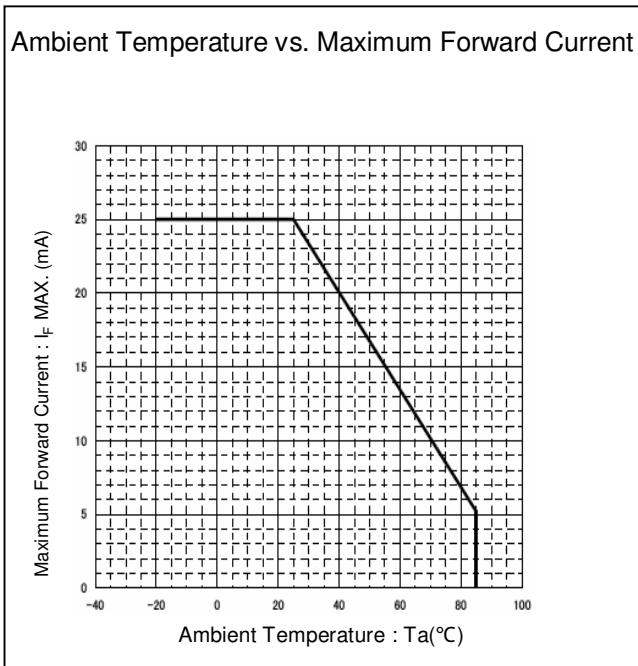
(Ta=25°C)

Item	Conditions	Symbol		Characteristics				Unit
				Orange		Red		
				Chip/Segment				
				1	2	1	2	
Luminous Intensity (-B Product)	I _F =20mA	I _v	MIN.	2	4	6	12	mcd/seg
			TYP.	4	8	12	24	
Luminous Intensity (-C Product)	I _F =20mA	I _v	MIN.	-	-	12	24	mcd/seg
			TYP.	-	-	15	30	
Forward Voltage	I _F =20mA	V _F	TYP.	2.2	4.4	1.7	3.4	V/seg
			MAX.	2.5	5.0	2.0	4.0	
Reverse Current	-	I _R	MAX.	100(V _R =4V)	100(V _R =8V)	100(V _R =4V)	100(V _R =8V)	μ A/seg
Peak Wavelength	I _F =20mA	λ _p	TYP.	605		660		nm
Spectral Line Half Width	I _F =20mA	Δλ	TYP.	30		30		nm

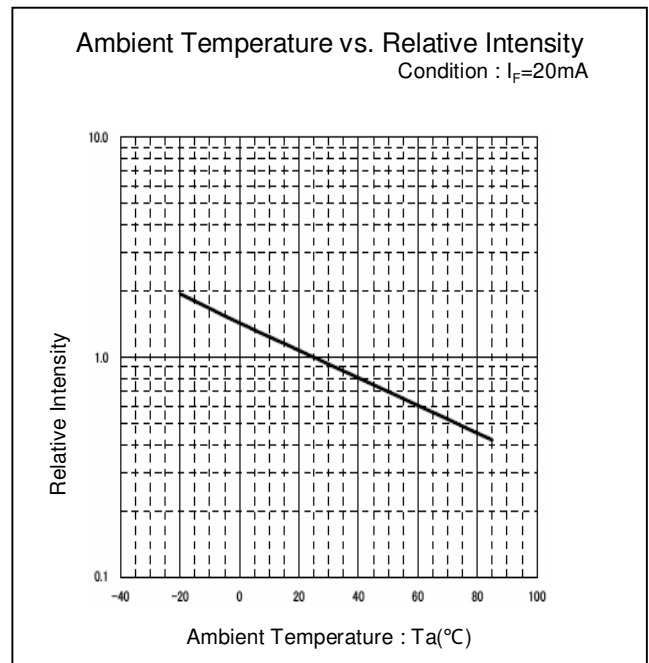
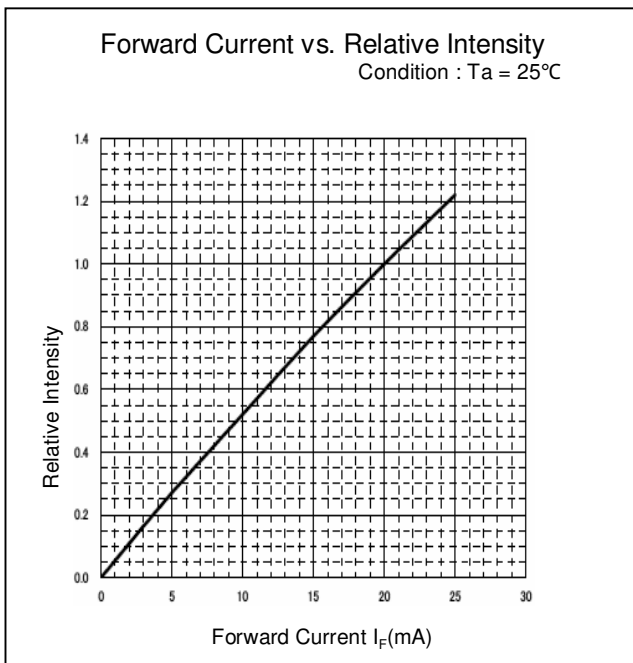
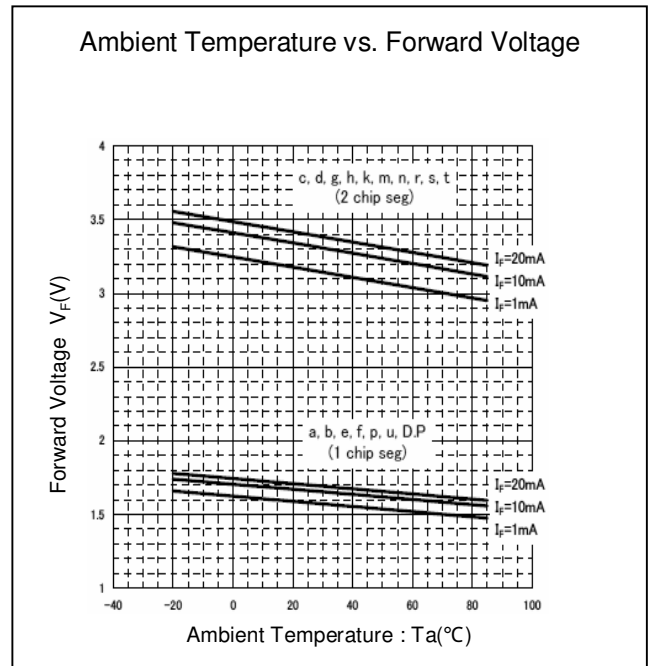
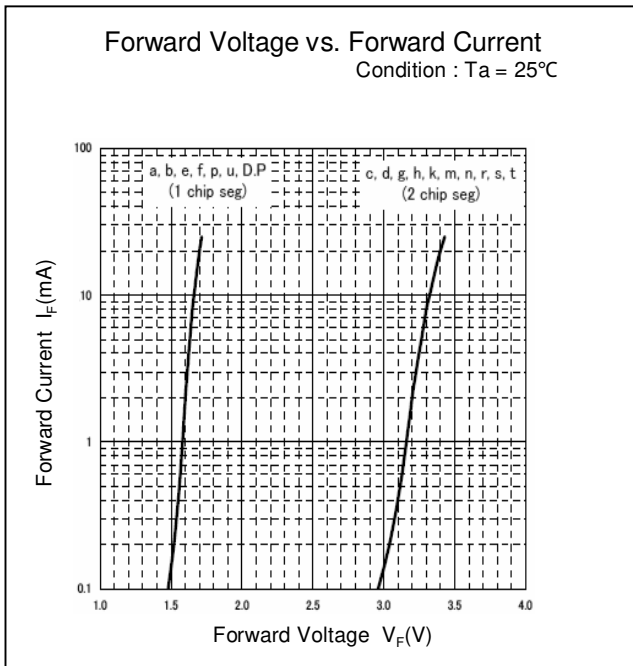
Technical Data(Orange)



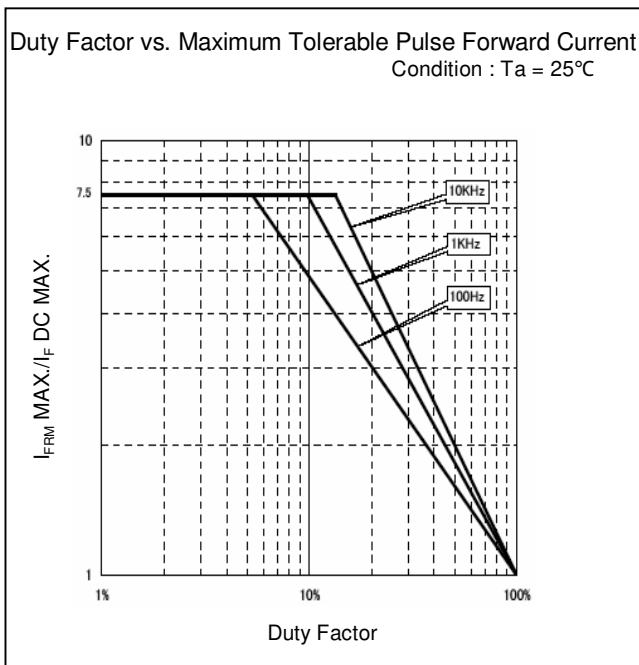
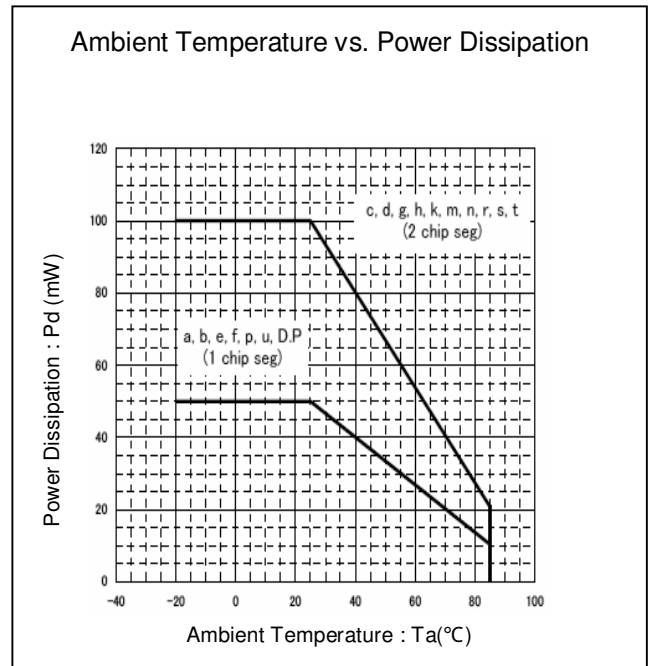
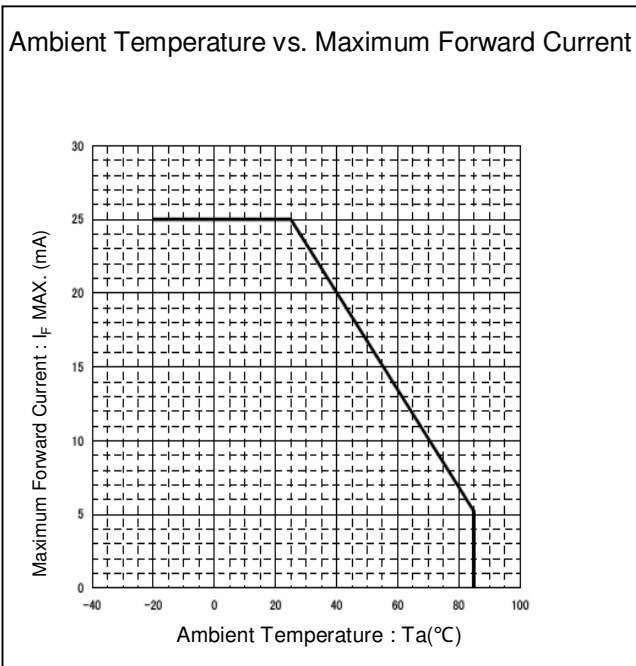
Technical Data(Orange)



Technical Data(Red)

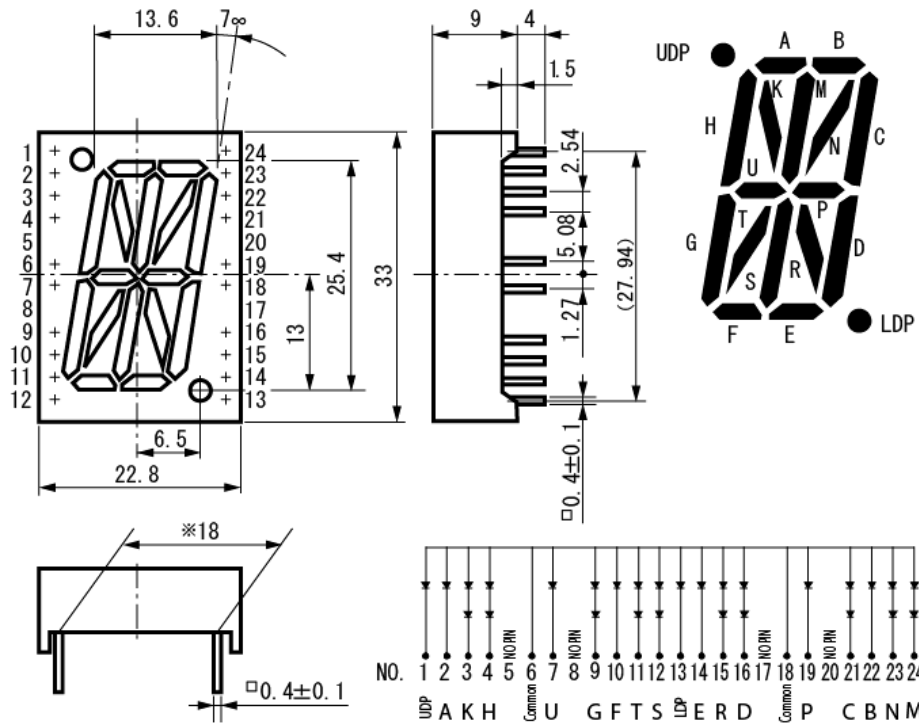


Technical Data(RED)



Package Dimensions

(Unit: mm)

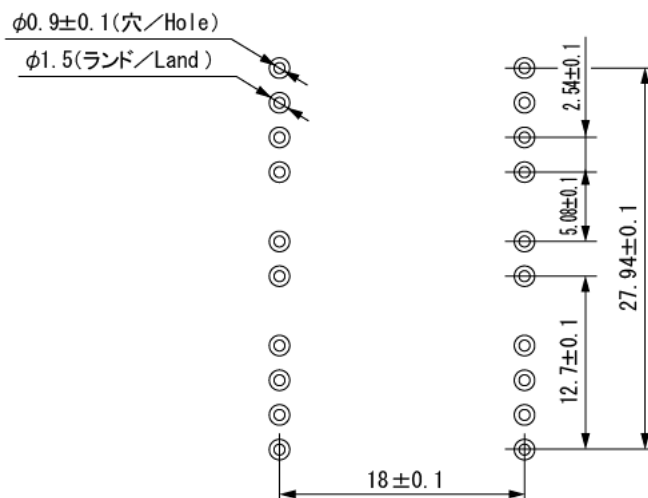


Tolerance : ± 0.25 mm

※ The length of lead base.

Recommended Soldering Pattern

(Unit: mm)



TTW (Through The Wave) soldering Conditions

Pre-heating	100 °C 60 s	(MAX.) Resin surface temperature (MAX.)
Solder Bath Temp.	265 °C	(MAX.)
Dipping Time	5 s	(MAX.)
Position	At least 2.0 mm away from the root of lead	

- 1) The dip soldering process shall be 2 times maximum.
- 2) The product shall be cooled to normal temperature before the second dipping process.

Manual Soldering Conditions

Iron tip temp.	400 °C	(MAX.) (30 W Max.)
Soldering time and frequency	3 s 2 times	(MAX.) (MAX.)
Position	At least 2.0 mm away from the root of lead	

Reliability Testing Result

Reliability Testing Result	Applicable Standard	Testing Conditions	Duration	Failure
Room Temp. Operating Life	BAJED-4701/100(101)	Ta = 25°C, If = Maximum Rated Current/seg	1,000 h	0/10
Resistance to Soldering Heat	BAJED-4701/300(302)	260± 5°C, 3mm from package base	10s	0/10
Temperature Cycling	BAJED-4701/100(105)	Minimum Rated Storage Temperature(30min) ~ Normal Temperature(15min) ~ Maximum Rated Storage Temperature(30min) ~ Normal Temperature(15min)	5 cycles	0/10
Wet High Temp. Storage Life	BAJED-4701/100(103)	Ta = 60± 2°C, RH = 90± 5%	1,000 h	0/10
High Temp. Storage Life	BAJED-4701/200(201)	Ta = Maximum Rated Storage Temperature	1,000 h	0/10
Low Temp. Storage Life	BAJED-4701/200(202)	Ta = Minimum Rated Storage Temperature	1,000 h	0/10
Lead Tension	BAJED-4701/400(401)	5N, 1time	10s	0/10
Vibration, Variable Frequency	BAJED-4701/400(403)	98.1m/s ² (10G), 100 ~ 2KHz sweep for 20min., XYZ each direction	2 h	0/10
Lead Bend	BAJED-4701/400(401)	2.5N, 0° ← → 90°	Twice	0/10
Shock	JSC 7201 A-8	It falls on wood engraving from height of 75cm.	3 times	0/10

Failure Criteria

Items	Symbols	Conditions	Failure criteria
Luminous Intensity	Iv	If Value of each product Luminous Intensity	Testing Min. Value < Spec. Min. Value x 0.5
Forward Voltage	V _F	If Value of each product Forward Voltage	Testing Max. Value ≥ Spec. Max. Value x 1.2
Reverse Current	I _R	V _R = Maximum Rated Reverse Voltage V	Testing Max. Value ≥ Spec. Max. Value x 2.5
Cosmetic Appearance	-	-	Occurrence of notable decoloration, deformation and cracking

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